



3N60-LC

Power MOSFET

3.0A, 600V N-CHANNEL POWER MOSFET

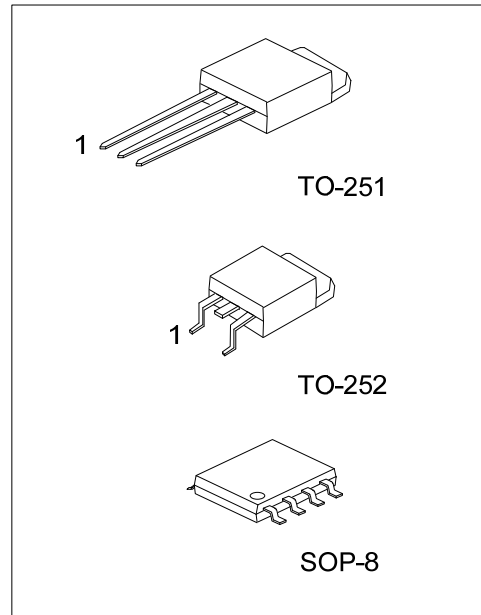
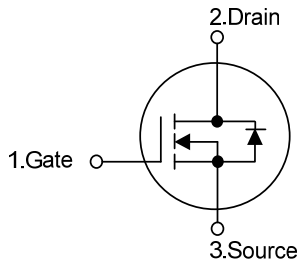
■ DESCRIPTION

The UTC **3N60-LC** is a high voltage power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

■ FEATURES

- * $R_{DS(ON)} \leq 3.0 \Omega @ V_{GS}=10V, I_D=1.5A$
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness

■ SYMBOL



■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment								Packing	
Lead Free	Halogen Free		1	2	3	4	5	6	7	8		
3N60L-TM3-T	3N60G-TM3-T	TO-251	G	D	S	-	-	-	-	-	-	Tube
3N60L-TN3-R	3N60G-TN3-R	TO-252	G	D	S	-	-	-	-	-	-	Tape Reel
3N60L-S08-R	3N60G-S08-R	SOP-8	S	S	S	G	D	D	D	D	D	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>3N60G-TM3-T</p> <p>(1) Packing Type (2) Package Type (3) Green Package</p>	<p>(1) T: Tube, R: Tape Reel (2) TM3: TO-251, TN3: TO-252, S08: SOP-8 (3) G: Halogen Free and Lead Free, L: Lead Free</p>
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■ MARKING

TO-251 / TO-252	SOP-8
<p>UTC 3N60</p> <p>Lot Code ← [] [] [] [] [] [] [] [] → Date Code</p> <p>L: Lead Free G: Halogen Free</p>	<p>[8] [7] [6] [5] → Date Code</p> <p>UTC [] [] [] [] → L: Lead Free</p> <p>3N60 [] [] → G: Halogen Free</p> <p>• [] [] [] [] → Lot Code</p> <p>[1] [2] [3] [4]</p>

■ ABSOLUTE MAXIMUM RATINGS (T_c=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	600	V
Gate-Source Voltage		V _{GSS}	±30	V
Continuous Drain Current		I _D	3	A
Pulsed Drain Current (Note 2)		I _{DM}	6	A
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	108	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.4	V/ns
Power Dissipation	TO-251/TO-252	P _D	48	W
	SOP-8		2.1	W
Junction Temperature		T _J	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. L = 30mH, I_{AS} = 2.68A, V_{DD} = 50V, R_G = 25 Ω, Starting T_J = 25°C

4. I_{SD} ≤ 3.0A, di/dt ≤ 200A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient (Note)	TO-251/TO-252	θ _{JA}	110	°C/W
	SOP-8		190	°C/W
Junction to Case (Note)	TO-251/TO-252	θ _{JC}	2.6 (Note)	°C/W
	SOP-8		59.5 (Note)	°C/W

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

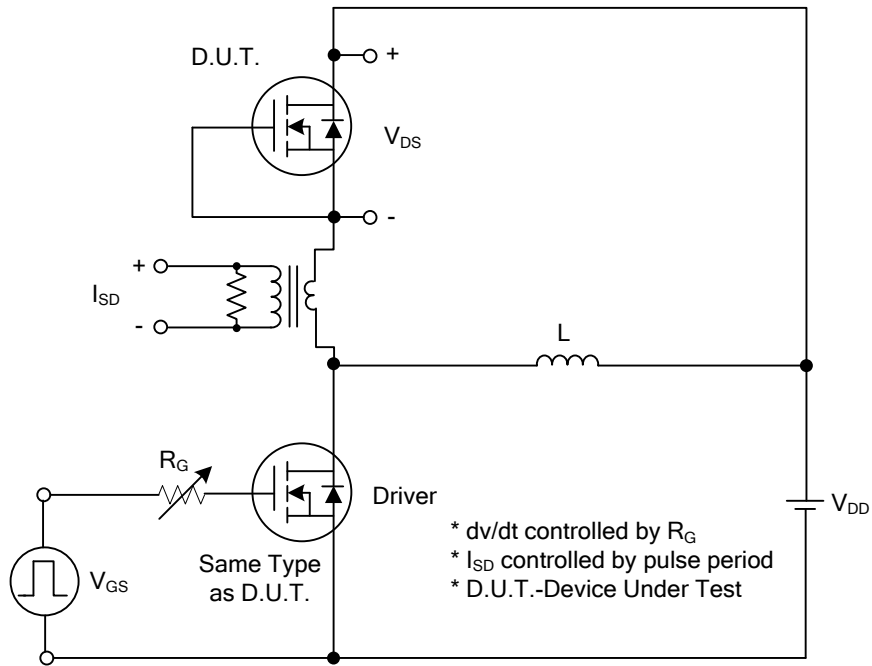
■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	600			V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =600V, V _{GS} =0V			10	μA
Gate- Source Leakage Current	Forward	I _{GSS} V _{GS} =30V, V _{DS} =0V			100	nA
	Reverse		V _{GS} =-30V, V _{DS} =0V			-100
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250μA	2.0		4.0	V
Static Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =1.5A			3.0	Ω
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{ISS}	V _{DS} =25V, V _{GS} =0V, f=1.0MHz		446		pF
Output Capacitance	C _{OSS}			46		pF
Reverse Transfer Capacitance	C _{RSS}			4.5		pF
SWITCHING CHARACTERISTICS						
Total Gate Charge (Note 1)	Q _G	V _{DS} =100V, V _{GS} =10V, I _D =2.0A I _G =1mA (Note 1, 2)		15.2		nC
Gate-Source Charge	Q _{GS}			5.4		nC
Gate-Drain Charge	Q _{GD}			1.8		nC
Turn-On Delay Time (Note 1)	t _{D(ON)}	V _{DS} =30V, V _{GS} =10V, I _D =0.5A, R _G =25Ω (Note 1, 2)		6.4		ns
Turn-On Rise Time	t _R			16.7		ns
Turn-Off Delay Time	t _{D(OFF)}			39		ns
Turn-Off Fall Time	t _F			27		ns
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
Maximum Continuous Drain-Source Diode Forward Current	I _S				3	A
Maximum Pulsed Drain-Source Diode Forward Current	I _{SM}				6	A
Drain-Source Diode Forward Voltage (Note 1)	V _{SD}	I _S =3.0A, V _{GS} =0V			1.4	V
Reverse Recovery Time (Note 1)	t _{rr}	I _S =3.0A, V _{GS} =0V di/dt=100A/μs		220		ns
Reverse Recovery Charge	Q _{rr}				3	

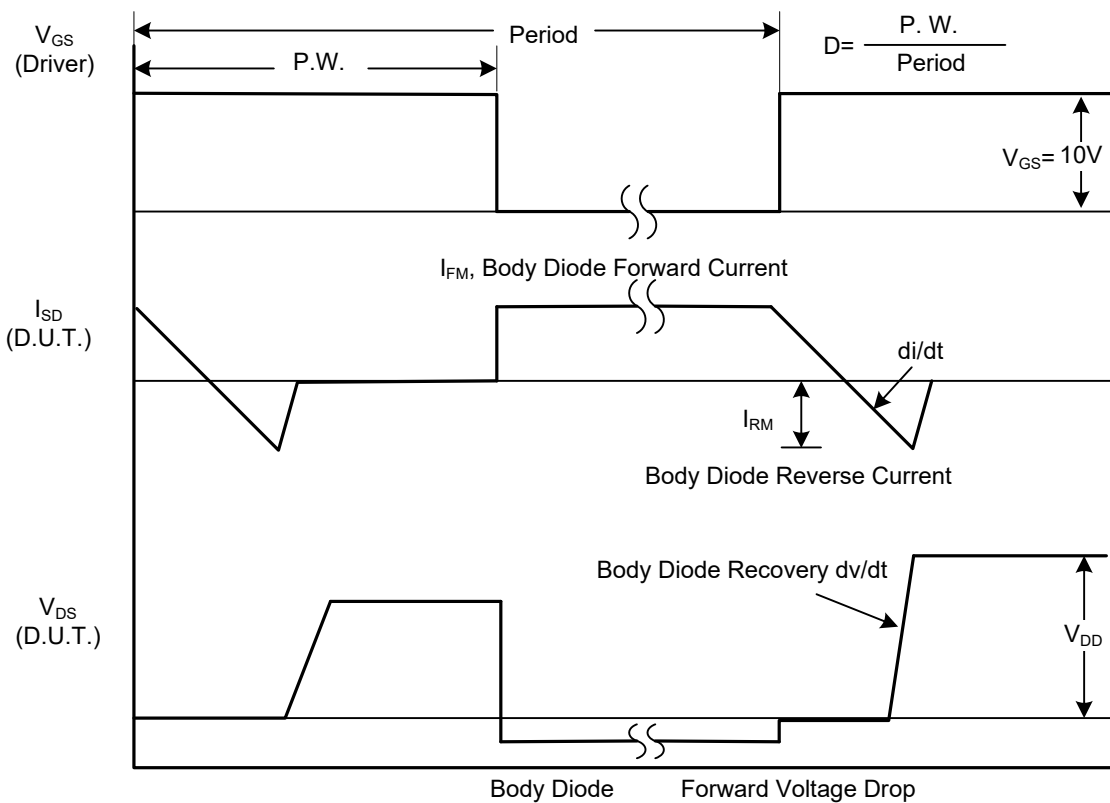
Notes: 1. Pulse Test: Pulse width ≤ 300μs, Duty cycle ≤ 2%.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

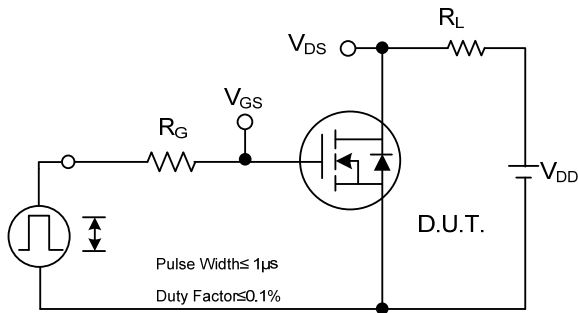


Peak Diode Recovery dv/dt Test Circuit

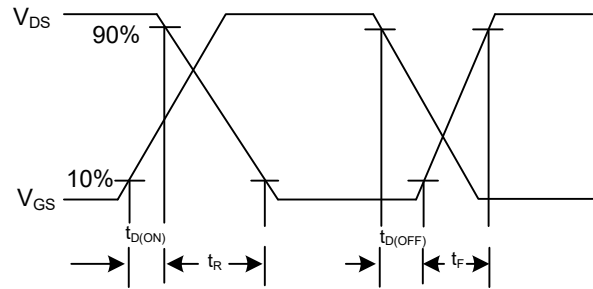


Peak Diode Recovery dv/dt Waveforms

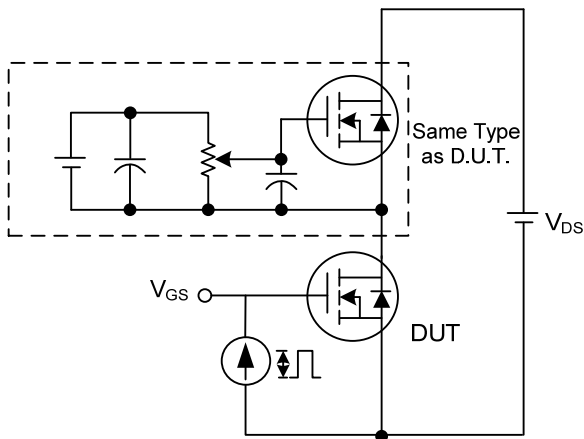
TEST CIRCUITS AND WAVEFORMS



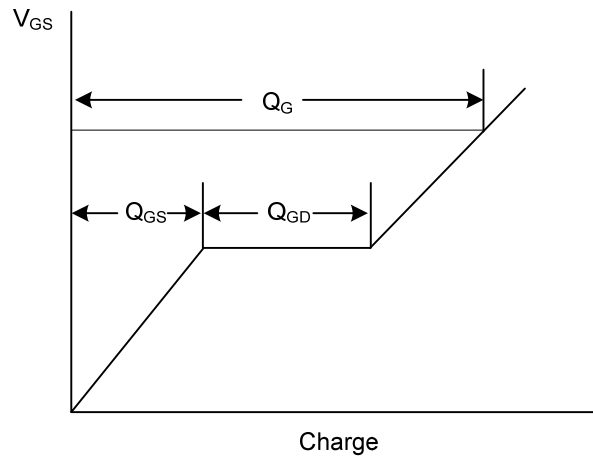
Switching Test Circuit



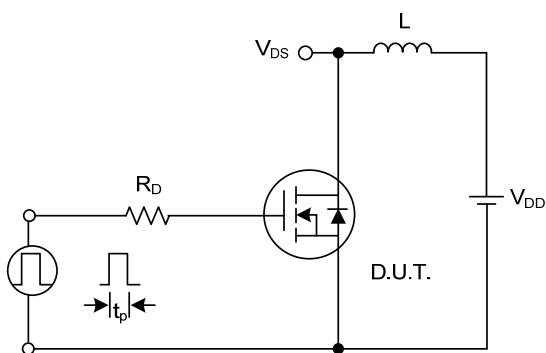
Switching Waveforms



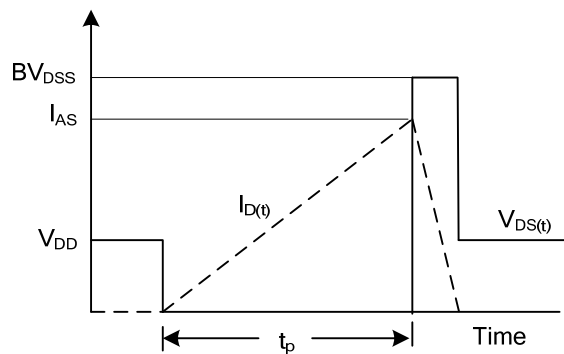
Gate Charge Test Circuit



Gate Charge Waveform

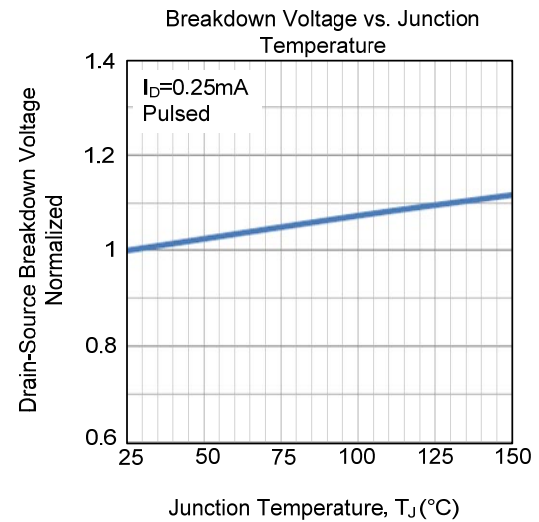
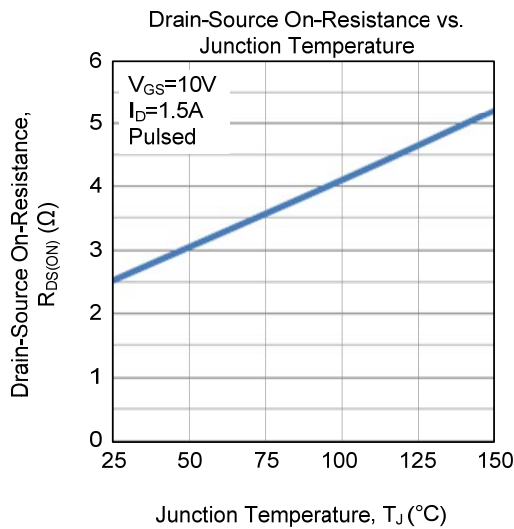
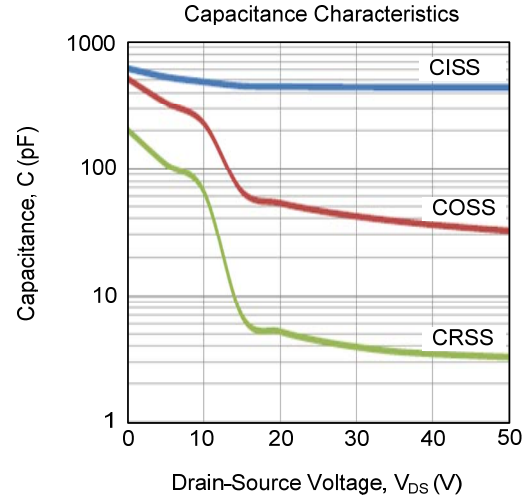
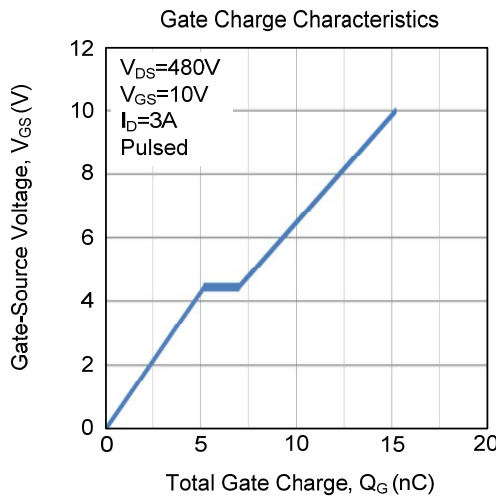
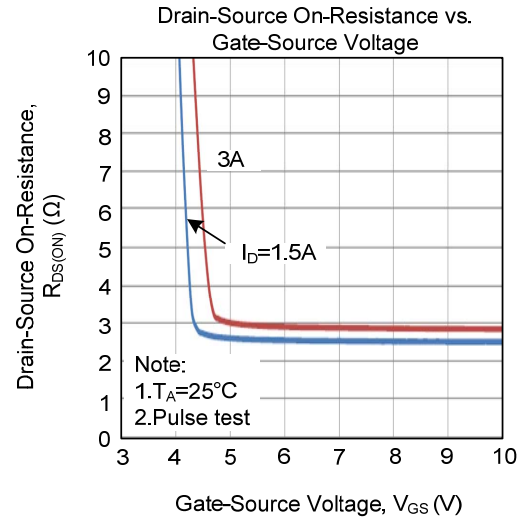
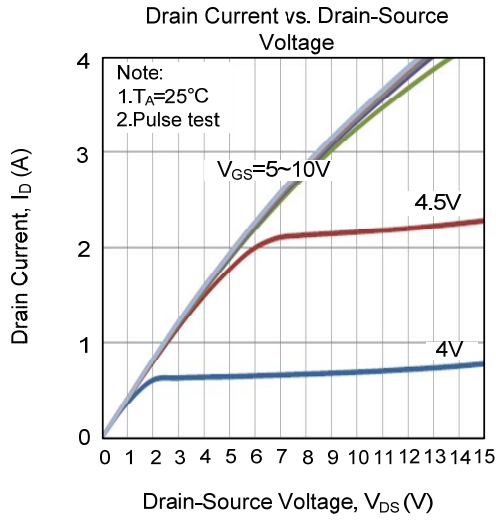


Unclamped Inductive Switching Test Circuit

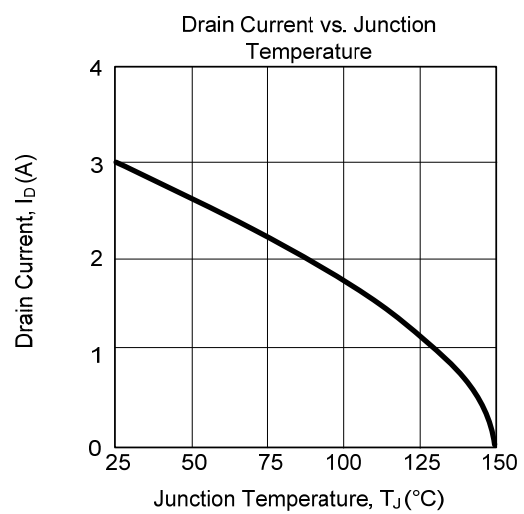
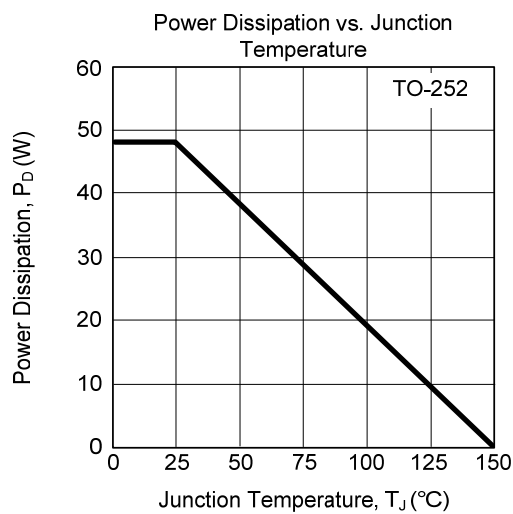
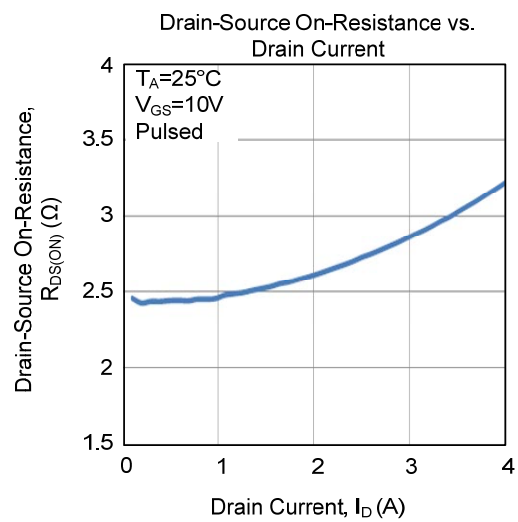
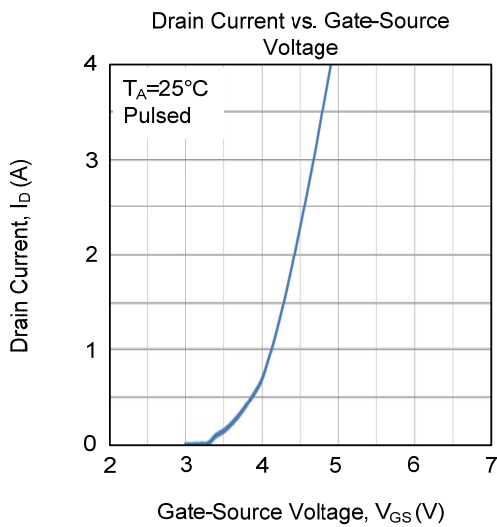
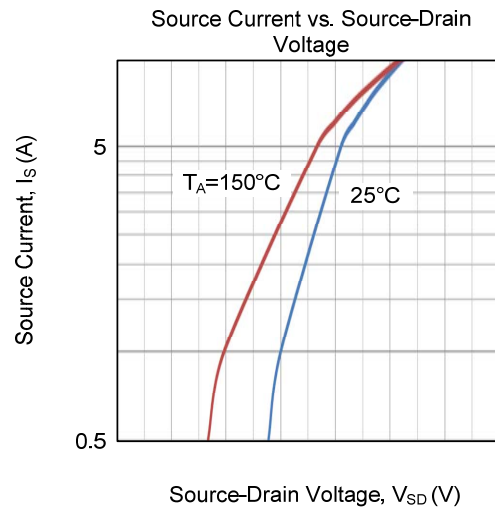
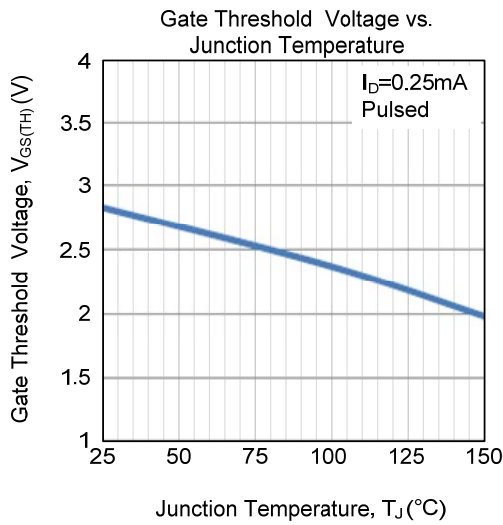


Unclamped Inductive Switching Waveforms

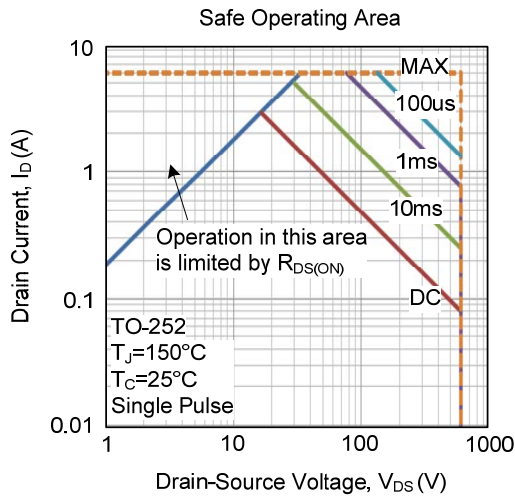
■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)



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